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FAIRCHILD

September 2014

# FPF2193 / FPF2194 / FPF2195 Full-Function Load Switch with Adjustable Current Limit

## **Features**

- <1.8 to 5.5 V Input Voltage Range</p>
- Controlled Turn-On
- 0.1 to 1.5 A Adjustable Current Limit
- Under-Voltage Lockout
- Thermal Shutdown
- <2 µA Shutdown Current</p>
- Auto Restart
- Fast Current Limit Response Time
- 5 µs to Moderate Over Currents
- 30 ns to Hard Shorts
- Fault Blanking
- Reverse Current Blocking

## **Applications**

- PDAs
- Cell Phones
- Handheld GPS Devices
- Portable Enterprise / Industrial Devices
- Digital Cameras
- Peripheral Ports and Accessories
- Portable Medical Equipment
- Hot Swap Supplies

## Description

The FPF2193, FPF2194, and FPF2195 form a series of load switches that provides full protection to systems and loads that may encounter large current conditions. These devices contain a 55 m $\Omega$  current-limited P-channel MOSFET that can operate over an input voltage range of 1.8 to 5.5 V. Internally, current is prevented from flowing when the MOSFET is off and the output voltage is higher than the input voltage. Switch control is by a logic input (ON) capable of interfacing directly with low-voltage control signals. Each part contains thermal shutdown protection that shuts off the switch to prevent damage to the part when a continuous over-current condition causes excessive heating.

When the switch current reaches the current limit, the parts operate in a constant-current mode to prohibit excessive currents from causing damage. For the FPF2193 and FPF2194, if the constant current condition still persists after 30 ms, the parts shut off the switch and pull the fault signal pin (FLAGB) LOW. The FPF2193 has an auto-restart feature that turns the switch on again after 450 ms if the ON pin is still active. The FPF2194 does not have this auto-restart feature, so the switch remains off until the ON pin is cycled. The FPF2195 does not turn off after a current limit fault, but remains in the constant-current mode indefinitely. The minimum current limit can be set as low as 45 mA.

These parts are available in a space-saving six ball advanced 0.98 x 1.48 mm WLCSP package.

## **Ordering Information**

Part Number	Current Limit [mA]	Current Limit Blanking Time [ms]	Auto-Restart Time [ms]	ON Pin Activity	Top Mark
FPF2193		15/30/60	225/450/900	Active HIGH	S6
FPF2194	100-1500	15/30/60	NA		S7
FPF2195		0	NA	Active nign	S9
FPF2195BUCX	45-1500	0	NA		SY

## **Application Diagram**

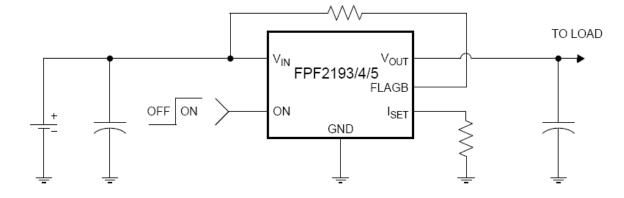


Figure 1. Typical Application

## **Block Diagram**

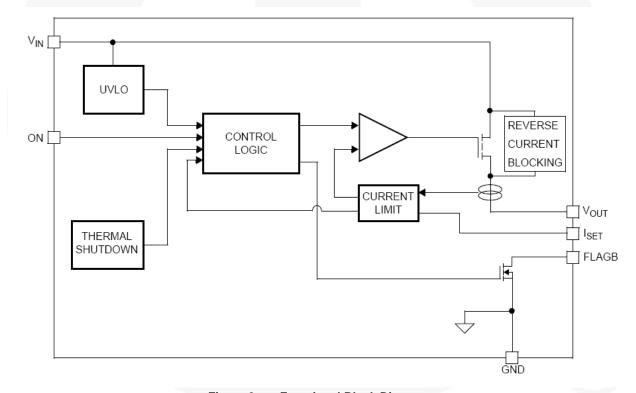


Figure 2. Functional Block Diagram

## **Pin Configuration**

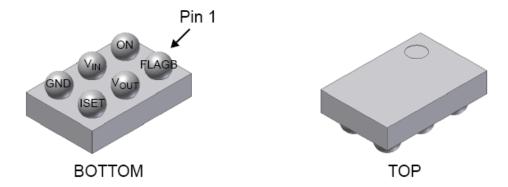


Figure 3. 1.0 x 1.5 mm Chip-Scale Package

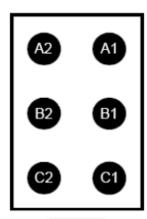


Figure 4. Pin Configuration (Bottom View)

## **Pin Definitions**

Pin#	Name	Description	
C1	I <sub>SET</sub>	Current Limit Set Input. A resistor from I <sub>SET</sub> to ground sets the current limit for the switch.	
B2	$V_{IN}$	Supply Input. Input to the power switch and the supply voltage for the IC.	
B1	$V_{OUT}$	Switch Output. Output of the power switch.	
A1	FLAGB	Fault Output. Active LOW, open-drain output that indicates an over-current supply, under-voltage, or over-temperature state.	
C2	GND	Ground.	
A2	ON	ON control input, active HIGH.	

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Unit	
	V <sub>IN</sub> , V <sub>OUT</sub> , ON, FLAGB, ISET to GND			6.0	V	
P <sub>D</sub>	Power Dissipation at T <sub>A</sub> = 25°C <sup>(1)</sup>			1.2	W	
TJ	Operating Temperature Range			+125	°C	
T <sub>STG</sub>	Storage Temperature		-65	+150	°C	
$\Theta_{JA}$	Thermal Resistance, Junction to Ambient			85	°C/W	
ESD	Flacture totic Discharge Conchility	Human Body Model, JESD22-A114	8000		V	
	Electrostatic Discharge Capability	Machine Model, JESD22-A115	400		V	

#### Note:

1. Package power dissipation on one-square inch pad, two-ounce copper board.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

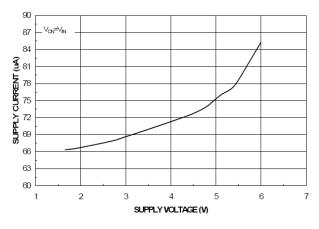
Symbol	Parameter		Max.	Unit
$V_{IN}$	Input Voltage	1.8	5.5	V
T <sub>A</sub>	Ambient Operating Temperature	-40	+85	°C

## **Electrical Characteristics**

 $V_{IN}$  = 1.8 to 5.5 V,  $T_A$  = -40 to +85°C unless otherwise noted. Typical values are at  $V_{IN}$  = 3.3 V and  $T_A$  = 25°C.

Symbol	Parameter Conditions		Min.	Тур.	Max.	Units		
Basic Ope	ration							
V <sub>IN</sub>	Operating Voltage			1.8		5.5	V	
			V <sub>IN</sub> =1.8 V		70			
$I_{Q}$	Quiescent Current	$I_{OUT}$ =0 mA, $V_{ON}$ = $V_{IN}$	V <sub>IN</sub> =3.3 V		75		μΑ	
			V <sub>IN</sub> =5.5 V		80			
R <sub>ON</sub>	On Resistance	T <sub>A</sub> =25°C, I <sub>OUT</sub> =200 n	nA		55	80	mΩ	
NON	On Resistance	T <sub>A</sub> =-40 to 85°C, I <sub>OUT</sub> =200 mA				135	11152	
$V_{IH}$	On Input Logic High Voltage	V <sub>IN</sub> =1.8 V		8.0			l v	
V IH	ON	V <sub>IN</sub> =5.5 V		1.4			, v	
$V_{IL}$	On Input Logic Low Voltage	V <sub>IN</sub> =1.8 V				0.5	V	
V IL	on input Logio Low Voltage	V <sub>IN</sub> =5.5 V				1.0	, v	
I <sub>IN</sub>	On Input Leakage	V <sub>ON</sub> =V <sub>IN</sub> or GND		-1	0	1	μA	
V <sub>IN_SD</sub>	V <sub>IN</sub> Shutdown Current	$V_{ON}$ =0 V, $V_{IN}$ =5.5 V, $V_{OUT}$ =Short to GND		-2		2	μΑ	
V	FLAGB Output Logic Low	V <sub>IN</sub> =5 V, I <sub>SINK</sub> =10 mA	<b>\</b>		0.05	0.20	V	
$V_{FLB\_L}$	Voltage	V <sub>IN</sub> =1.8 V, I <sub>SINK</sub> =10 n	nA		0.12	0.30	V	
I <sub>FLB_H</sub>	FLAGB Output Logic High Leakage Current	V <sub>IN</sub> =5 V, Switch ON				1	μA	
Reverse B	lock			1				
I <sub>SDT</sub>	V <sub>OUT</sub> Shutdown Current	$V_{ON}$ =0 V, $V_{OUT}$ =5.5 V $V_{IN}$ =Short-to-GND	<b>′</b> ,	-2		2	μA	
V <sub>breakdown</sub>	Reverse Breakdown Voltage	V <sub>IN</sub> =V <sub>ON</sub> =0 V, I <sub>OUT</sub> =2	00 μΑ		9		V	
Protection	s							
	Current Limit	V <sub>IN</sub> =3.3 V, V <sub>OUT</sub> =3.0	V, R <sub>SET</sub> =690 Ω	600	800	1000	mA	
I <sub>LIM</sub>	Current Limit for FPF2195BUCX	$V_{IN}$ =4.5 V, $V_{OUT}$ =4.2 R <sub>SET</sub> =15.8 K $\Omega$	V,	35	45	60	mA	
I <sub>LIM(MIN)</sub>	Minimum Current Limit	$V_{IN}$ =3.3 V, $V_{OUT}$ =3.0 V, $R_{SET}$ =5516 $\Omega$			100		ma	
		Shutdown Threshold			140			
$T_{SD}$	Thermal Shutdown	Return from Shutdown			130		°C	
		Hysteresis			10			
V <sub>UVLO</sub>	Under-Voltage Lockout	V <sub>IN</sub> Increasing		1.55	1.65	1.75	V	
V <sub>UVLO_HYST</sub>	Under-Voltage Lockout Hysteresis				50		mV	
Dynamic								
td <sub>ON</sub>	Delay On Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			20		μs	
t <sub>R</sub>	V <sub>OUT</sub> Rise Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			20		μs	
t <sub>ON</sub>	Turn-On Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			40		μs	
td <sub>OFF</sub>	Delay Off Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			15		μs	
t <sub>F</sub>	V <sub>OUT</sub> Fall Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			110		μs	
t <sub>OFF</sub>	Turn-Off Time	R <sub>L</sub> =500 Ω, C <sub>L</sub> =0.1 μF			125		μs	
t <sub>BLANK</sub>	Over-Current Blanking Time	FPF2193, FPF2194		15	30	60	ms	
t <sub>RSTRT</sub>	Auto-Restart	FPF2193 Only		225	450	900	ms	
		V <sub>IN</sub> =V <sub>OUT</sub> =3.3 V, Mod	derate Over-	-	5		μs	
t <sub>sc</sub>	Short-Circuit Response Time	Current Condition						

## **Typical Performance Characteristics**



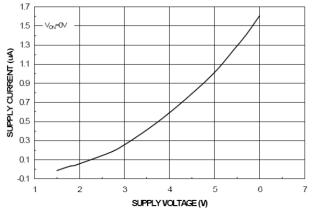


Figure 5. Quiescent Current vs. Input Voltage

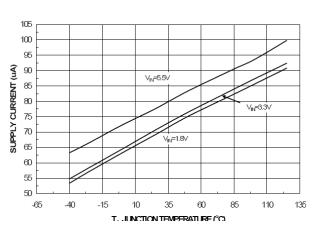


Figure 6. Quiescent Current vs. Input Voltage

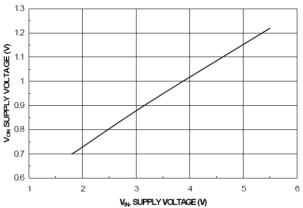


Figure 7. Quiescent Current vs. Temperature

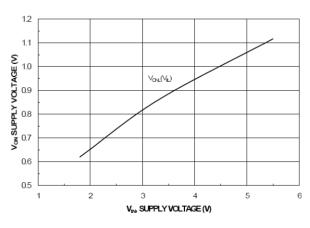


Figure 8. V<sub>ON</sub> High Voltage vs. Input Voltage

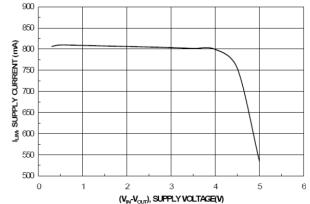
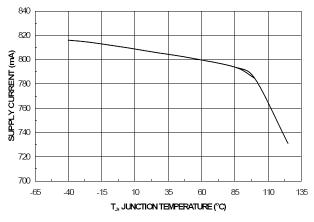


Figure 9. Von Low Voltage vs. Input Voltage

Figure 10. Current Limit vs. Output Voltage

## **Typical Performance Characteristics** (Continued)



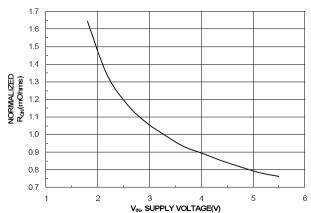
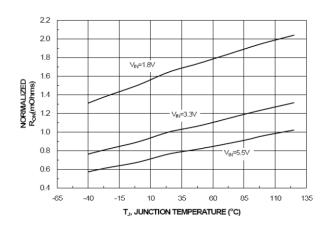


Figure 11. Current Limit vs. Temperature





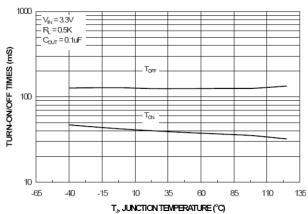


Figure 13. Ron vs. Temperature

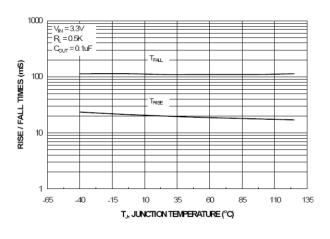


Figure 14. ton / toff vs. Temperature

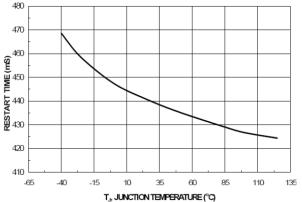
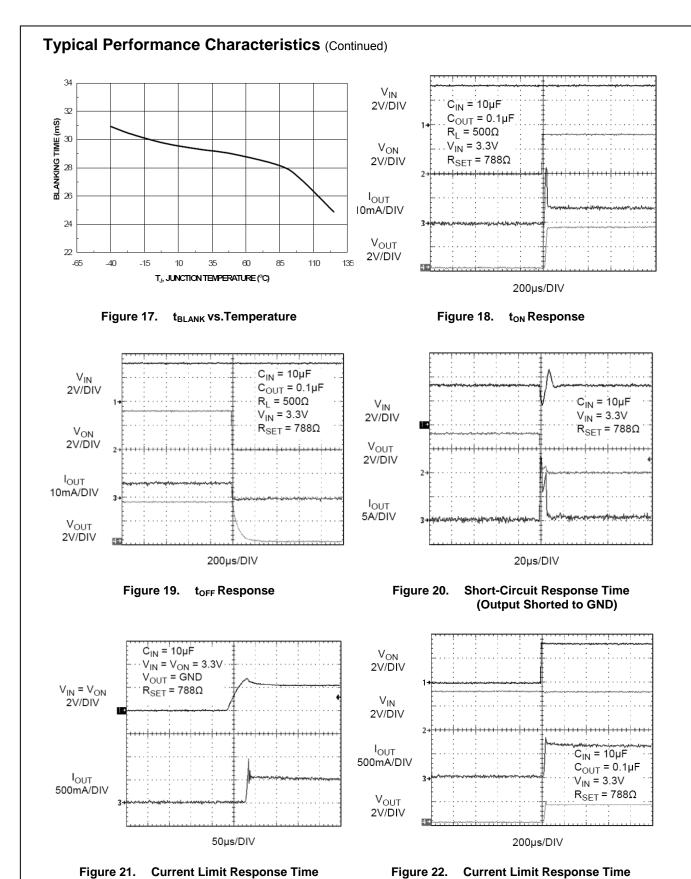


Figure 15.  $t_{RISE}$  /  $t_{FALL}$  vs. Temperature

Figure 16. t<sub>RSTRT</sub> vs. Temperature



(Output is Loaded by 2.2  $\Omega$ , C<sub>OUT</sub>=0.1  $\mu$ F)

(Switch is Powered into a Short)

## **Typical Performance Characteristics** (Continued)

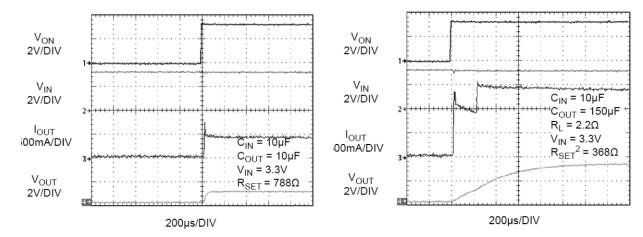


Figure 23. Current Limit Response Time (Output is Loaded by 2.2  $\Omega$ , C<sub>OUT</sub>=10  $\mu$ F)

Figure 24. Short-Circuit Detection Function<sup>(2)</sup>

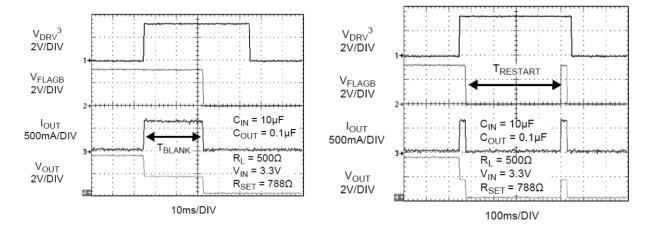


Figure 25. t<sub>BLANK</sub> vs. Response<sup>(3)</sup>

Figure 26. t<sub>RESTART</sub> vs. Response<sup>(3)</sup>

#### Notes:

- 2. When the output voltage is below V<sub>SCTH</sub>=1.1 V, the current limit value is set at 62.5% of the current limit value.
- 3.  $V_{DRV}$  signal forces the device to go into over-current condition by loading.

## **Functional Description**

The FPF2193, FPF2194, and FPF2195 are current-limited switches that protect systems and loads that can be damaged or disrupted by the application of high currents. The core of each device is a  $55~\text{m}\Omega$  P-channel MOSFET and a controller capable of functioning over the wide input operating range of 1.8- 5.5~V. The controller protects against system malfunctions through current limiting, under-voltage lockout, and thermal shutdown. The current limit is adjustable from 100 mA (45~mA for FPF2195BUCX) to 1.5 A through the selection of an external resistor.

#### **On/Off Control**

The ON pin controls the state of the switch. When ON is HIGH, the switch is in ON state. Activating ON continuously holds the switch in the ON state so long as there is no fault. For all versions, an under-voltage on VIN or a junction temperature in excess of 140°C overrides the ON control to turn off the switch. In addition, excessive currents cause the switch to turn off in the FPF2193 and FPF2194. The FPF2193 has an autorestart feature that automatically turns the switch on again after 450 ms. For the FPF2194, the ON pin must be toggled to turn the switch on again. The FPF2195 does not turn off in response to an over-current condition, but remains operating in constant-current mode as long as ON is active and the thermal shutdown or under-voltage lockout have not activated.

## **Fault Reporting**

Upon the detection of an over-current, input undervoltage, or over-temperature condition, FLAGB signals the fault mode by activating LOW. For the FPF2193 and FPF2194, the FLAGB goes LOW at the end of the blanking time, while FLAGB goes LOW immediately for the FPF2195. FLAGB remains LOW through the autorestart time for the FPF2195. For the FPF2194, FLAGB is latched LOW and ON must be toggled to release it. With the FPF2195, FLAGB is LOW during the faults and immediately returns HIGH at the end of the fault condition. FLAGB is an open-drain MOSFET that requires a pull-up resistor between  $V_{\rm IN}$  and FLAGB. During shutdown, the pull-down on FLAGB is disabled to reduce current draw from the supply.

#### **Current Limiting**

The current limit ensures that the current through the switch doesn't exceed a maximum value, while not limiting at less than a minimum value. The current at which the parts limit is adjustable through the selection of an external resistor connected to  $I_{\text{SET}}.$  Information for selecting the resistor is found in the Application Information section. The FPF2193 and FPF2194 have a blanking time of 30 ms, nominally, during which the switch acts as a constant current source. At the end of the blanking time, the switch is turned off. The FPF2195 has no current limit blanking period, so it remains in a constant current state until the ON pin is deactivated or the thermal shutdown turns off the switch.

For preventing the switch from large power dissipation during heavy load, a short-circuit detection feature is introduced. Short-circuit condition is detected by, observing the output voltage. The switch is put into short-circuit current-limiting mode if the switch is loaded with a

heavy load. When the output voltage drops below  $V_{\text{SCTH}}$ , the short-circuit detection threshold voltage, the current limit value is re-conditioned and the short-circuit current-limit value is decreased to 62.5% of the current limit value. This keeps the power dissipation of the part below a certain limit even at dead-short conditions at 5.5 V input voltage. The  $V_{\text{SCTH}}$  value is set to be 1 V. At around 1.1 V of output voltage, the switch is removed from short-circuit current-limiting mode and the current limit is set to the current limit value.

#### **Under-Voltage Lockout (UVLO)**

The under-voltage lockout turns the switch off if the input voltage drops below the under-voltage lockout threshold. With the ON pin active, the input voltage rising above the under-voltage lockout threshold causes a controlled turn-on of the switch, which limits current over shoot.

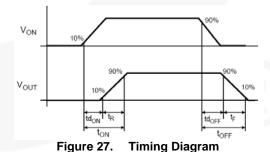
#### **Thermal Shutdown**

The thermal shutdown protects the die from internally or externally generated excessive temperatures. During an over-temperature condition, FLAGB is activated and the switch is turned off. The switch automatically turns on again if temperature of the die drops below the threshold temperature.

## **Reverse-Current Blocking**

The entire FPF2193/94/95 family has a reverse current blocking feature that protects the input source against current flow from output to input. For a standard USB power design, this is an important feature to protect the USB host from being damaged due to reverse current flow on  $V_{\text{BUS}}$ .

When the load switch is OFF, no current flows from the output to the input. If the switch is turned on and the output voltage is greater than input voltage, this feature is activated and turns off the switch. This prevents any current flow from output to input. The reverse-current blocking feature is deactivated if the  $V_{\text{OUT}}$  -  $V_{\text{IN}}$  is smaller than a typically 50 mV threshold. During this time, some current (50 mV/R<sub>ON</sub>) flows from the output to input until input voltage becomes greater than output voltage. FLAGB operation is independent of the reverse-current blocking and does not report a fault condition if this feature is activated.



where:  $td_{\text{ON}} = \text{Delay On Time} \\ t_{\text{R}} = V_{\text{OUT}} \text{ Rise Time} \\ t_{\text{ON}} = \text{Turn-On Time} \\ td_{\text{OFF}} = \text{Delay Off Time} \\ t_{\text{F}} = V_{\text{OUT}} \text{ Fall Time} \\ t_{\text{OFF}} = \text{Turn-Off Time}$ 

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## **Application Information**

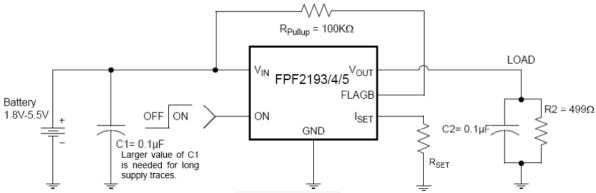


Figure 28. Typical Application

## **Setting Current Limit**

The FPF2193, FPF2194, and FPF2195 current limit is set with an external resistor connected between  $I_{\text{SET}}$  and GND. This resistor is selected using the following equation:

$$R_{SET} = \frac{551.6}{I_{LIM}} \tag{1}$$

 $R_{SET}$  is in  $\Omega$  and  $I_{SET}$  is in Amps.

Table 1 can also be used to select  $R_{\text{SET}}.$  A typical application would be the 500 mA current required by a single USB port. Using Table 1, an appropriate selection for the  $R_{\text{SET}}$  resistor would be 788  $\Omega.$  This ensures that the port load could draw 525 mA, but not more than 875 mA. Likewise for a dual-port system; an  $R_{\text{SET}}$  of 368  $\Omega$  always delivers at least 1125 mA and never more than 1875 mA.

Table 1. Current Limit Various R<sub>SET</sub> Values

R <sub>SET</sub> (Ω)	Min. Current Limit (mA)	Typ. Current Limit (mA)	Max. Current Limit (mA)
368	1125	1500	1875
441	928	1250	1562
552	750	1000	1250
613	675	900	1125
690	600	800	1000
788	525	700	875
919	450	600	750
1103	375	500	625
1226	338	450	563
1379	300	400	500
1576	263	350	438
1839	225	300	375
2206	188	250	313
2758	150	200	250
3677	113	150	188
5516	75	100	125
15800 <sup>(4)</sup>	35	45	60

#### Note:

4. FPF2195BUCX only.

## Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush currents when the switch is turned on into a discharged load capacitor or a short-circuit, a capacitor needs to be placed between  $V_{\text{IN}}$  and GND. A 0.1  $\mu\text{F}$  ceramic capacitor,  $C_{\text{IN}}$ , placed close to the pins is usually sufficient. Higher values of  $C_{\text{IN}}$  can be used to further reduce the voltage drop.

## **Output Capacitor**

A 0.1  $\mu F$  capacitor,  $C_{OUT}$ , should be placed between  $V_{OUT}$  and GND. This capacitor prevents parasitic board inductances from forcing  $V_{OUT}$  below GND when the switch turns off. For the FPF2193 and FPF2194, the total output capacitance needs to be kept below a maximum value,  $C_{OUT}(max)$ , to prevent the part from registering an over-current condition and turning off the switch. The maximum output capacitance can be determined from the following formula:

$$C_{OUT}(max) = \frac{I_{LIM}(max) \times t_{BLANK}(min)}{V_{IN}}$$
 (2)

#### **Power Dissipation**

During normal operation as a switch, the power dissipated depends upon the level at which the current limit is set. The maximum allowed setting for the current limit is 1.5 A and results in a power dissipation of:

$$P = (I_{LIM})^2 \times R_{ON} = (1.5)^2 \times 0.055 = 123.75 \text{mW}$$
 (3)

If the part goes into current limit, the maximum power dissipation occurs when the output is shorted to ground. For the FPF2193, the power dissipation scales by the auto-restart time,  $t_{RSTRT}$ , and the over-current blanking time,  $t_{BLANK}$ , so that the maximum power dissipated is:

$$P(\text{max}) = \frac{t_{\text{BLANK}}}{t_{\text{BLANK}} + t_{\text{RSTRT}}} \times V_{\text{IN}}(\text{max}) \times I_{\text{LIM}}(\text{max})$$

$$= \frac{30}{30 + 450} \times 5.5 \times 1.5 = 515.6 \text{mW}$$
(4)

This is more power than the package can dissipate, but the thermal shutdown of the part activates to protect the part from damage due to excessive heating. When using the FPF2194, attention must be given to the manual resetting of the part. The junction temperature is only able to increase to the thermal shutdown threshold. Once this temperature has been reached, toggling ON does not turn the switch on until the junction temperature drops. For the FPF2195, a short on the output causes the part to operate in a constant-current state, dissipating a worst-case power of:

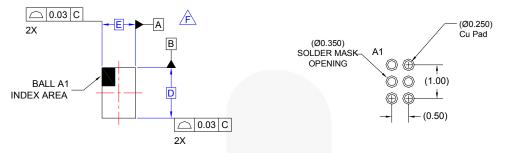
$$P(max) = V_{IN}(max) \times I_{LIM}(max)$$
  
= 5.5×1.5 = 8.25W (5)

This large amount of power activates the thermal shutdown and the part cycles in and out of thermal shutdown as long as the ON pin is active and the short is present.

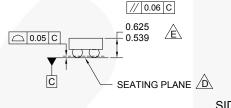
#### **Board Layout**

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal and short-circuit operation. Using wide traces for  $V_{\text{IN}}$ ,  $V_{\text{OUT}}$ , and GND help to minimize parasitic electrical effects along with minimizing the case-to-ambient thermal impedance.

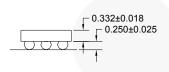
## **Physical Dimensions**



**TOP VIEW** 



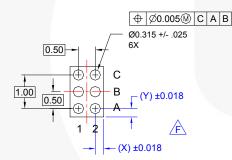
RECOMMENDED LAND PATTERN (NSMD PAD TYPE)



SIDE VIEWS

#### NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M. 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC006AFrev2.



**BOTTOM VIEW** 

Figure 29. 6-Ball, Wafer-Level Chip-Scale Package (WLCSP)

D	E	X	Y
1.480±0.030	0.980±0.030	0.240	0.240



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